

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T. UCHIDA, et al.

Application No.: 09/869,347

Filed: SEPTEMBER 7, 2001

For: MATERIALS FOR POLISHING LIQUID FOR METAL,  
POLISHING LIQUID FOR METAL, METHOD FOR  
PREPARATION THEREOF AND POLISHING METHOD USING  
THE SAME

Group A U: 2813

Examiner: L. M. Schillinger

Confirm. No: 4090

AMENDMENT**Mail Stop: AMEND – FEE**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

January 3, 2006

Sir:

In response to the Office Action mailed October 3, 2005, which held that the Amendment submitted July 12, 2005 was non-responsive, the period for response having been extended for two (2) months by the attached Petition for Extension of Time, please amend the above-identified application as listed in the following, and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.

